



### 100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>C</sub> = +25°C	
100V	28mΩ @ V <sub>GS</sub> = 10V	60A	

### **Description**

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

## **Applications**

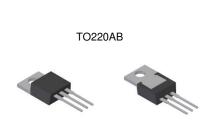
- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

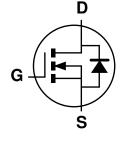
### **Features**

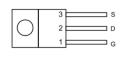
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching ensures more reliable and robust end application
- Low Input Capacitance
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: TO220AB
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 63
- Terminal Connections: See Diagram Below
- Weight: TO220AB 1.85 grams (Approximate)







Bottom View Equivalent Circuit

Top View
Pin Out Configuration

### **Ordering Information** (Note 4)

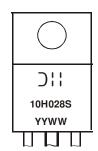
Top View

- 1			
	Part Number	Case	Packaging
	DMNH10H028SCT	TO220AB	50 pieces/tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



O'll = Manufacturer's Marking 10H028S = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 16 = 2016) WW = Week (01 to 53)



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	$V_{DSS}$	100	V	
Gate-Source Voltage	V <sub>GSS</sub>	±20	V	
Continuous Drain Current, V <sub>GS</sub> = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I <sub>D</sub>	60 42	А
Pulsed Drain Current (380μs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	90	Α	
Maximum Continuous Body Diode Forward Current (Note 5)	Is	2.8	Α	
Avalanche Current, L = 0.1mH	I <sub>AS</sub>	27	Α	
Avalanche Energy, L = 0.1mH	E <sub>AS</sub>	37	mJ	

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P <sub>D</sub>	2.8	W
Thermal Resistance, Junction to Ambient (Note 5)  Steady State		$R_{\theta JA}$	54	°C/W
Thermal Resistance, Junction to Case		$R_{ heta JC}$	1	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +175	°C

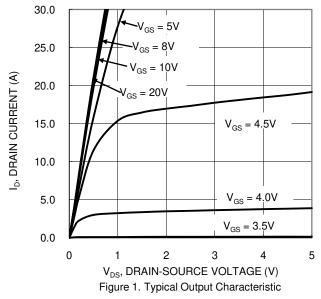
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

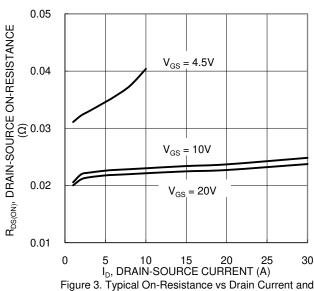
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
	Symbol	IVIIII	Тур	IVIAX	Unit	rest Condition
OFF CHARACTERISTICS (Note 6)	1	100	1	ı		T
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current, T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 100V, V_{GS} = 0V$
Gate-Source Leakage	$I_{GSS}$	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	$V_{GS(TH)}$	2.0	2.8	4.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	19	28	mΩ	$V_{GS} = 10V, I_D = 20A$
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1.0A$
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	C <sub>iss</sub>	_	1942	_	pF	V 50V V 0V
Output Capacitance	Coss	_	166	_	pF	$V_{DS} = 50V, V_{GS} = 0V,$ - f = 1MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	47	_	pF	-1 = 11VII 12
Gate Resistance	$R_g$	_	1.8	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 8V)	$Q_g$	_	25.4	_	nC	
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$	_	31.9	_	nC	$V_{DS} = 50V, I_{D} = 20A$
Gate-Source Charge	$Q_{gs}$	_	8.1	_	nC	VDS = 30V, ID = 20A
Gate-Drain Charge	$Q_{gd}$	_	6.5	_	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	7.1	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	6.6	_	ns	$V_{GS} = 10V, V_{DS} = 50V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	14.0	_	ns	$R_G = 3\Omega$ , $I_D = 20A$
Turn-Off Fall Time	t <sub>F</sub>	_	3.2	_	ns	
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	35.3	_	ns	$I_F = 20A$ , $di/dt = 100A/\mu s$
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	46.8	_	nC	$I_F = 20A$ , $di/dt = 100A/\mu s$

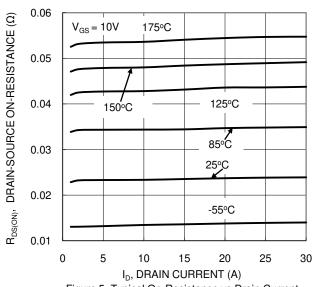
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:

## DMNH10H028SCT



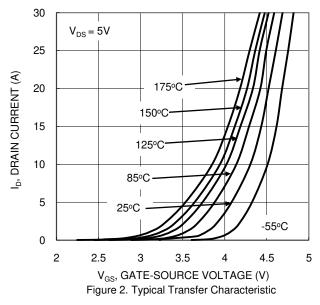


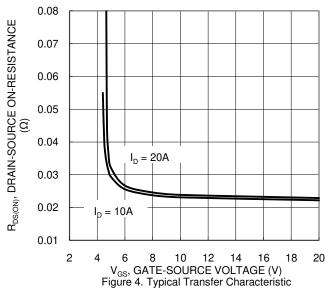




Gate Voltage

Figure 5. Typical On-Resistance vs Drain Current and Temperature





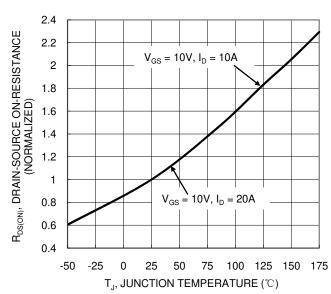


Figure 6. On-Resistance Variation with Temperature





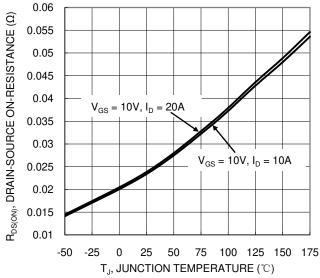
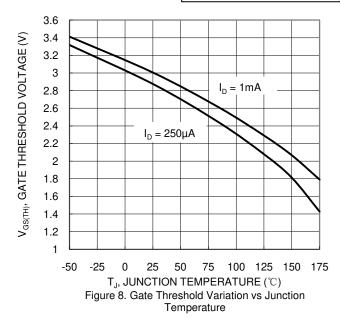
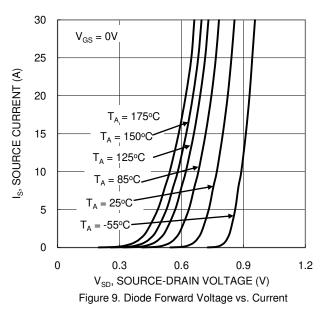


Figure 7. On-Resistance Variation with Temperature





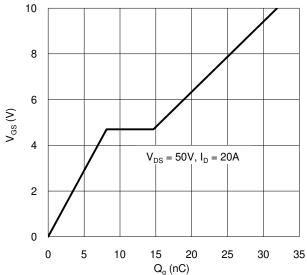
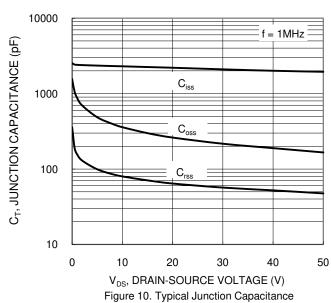
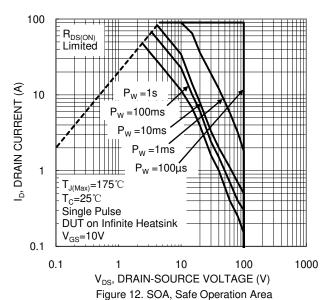
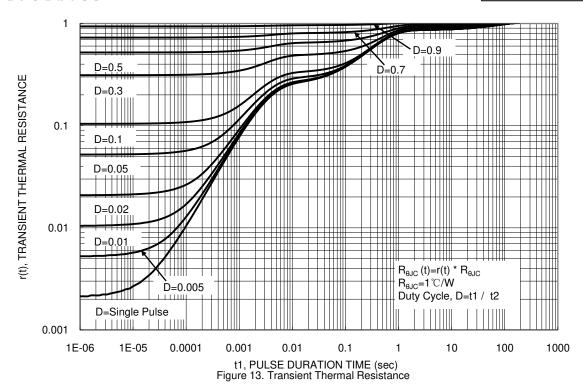


Figure 11. Gate Charge







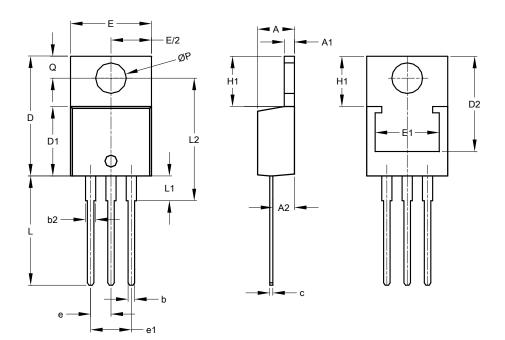




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **TO220AB**



TO220AB						
Dim	Min	Max	Тур			
Α	3.56	4.82	-			
<b>A</b> 1	0.51	1.39	-			
A2	2.04	2.92	-			
b	0.39	1.01	0.81			
b2	1.15	1.77	1.24			
С	0.356	0.61	1			
D	14.22	16.51	ı			
D1	8.39	9.01	1			
D2	11.45	12.87	-			
е	-	1	2.54			
e1	-	-	5.08			
Е	9.66	10.66	-			
E1	6.86	8.89	-			
H1	5.85	6.85	-			
L	12.70	14.73	-			
L1	-	6.35	-			
L2	15.80	16.20	16.00			
Р	3.54	4.08	-			
Q	2.54	3.42	-			
All Dimensions in mm						



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